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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	13
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	FLASH
EEPROM Size	64 x 8
RAM Size	68 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	·
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	18-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf84a-04-so

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Pin Name	PDIP No.	SOIC No.	SSOP No.	I/O/P Type	Buffer Type	Description
OSC1/CLKIN	16	16	18	I	ST/CMOS ⁽³⁾	Oscillator crystal input/external clock source input.
OSC2/CLKOUT	15	15	19	0	_	Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. In RC mode, OSC2 pin outputs CLKOUT, which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.
MCLR	4	4	4	I/P	ST	Master Clear (Reset) input/programming voltage input. This pin is an active low RESET to the device.
						PORTA is a bi-directional I/O port.
RA0	17	17	19	I/O	TTL	
RA1	18	18	20	I/O	TTL	
RA2	1	1	1	I/O	TTL	
RA3	2	2	2	I/O	TTL	
RA4/T0CKI	3	3	3	I/O	ST	Can also be selected to be the clock input to the TMR0 timer/counter. Output is open drain type.
RB0/INT	6	6	7	I/O	TTL/ST ⁽¹⁾	PORTB is a bi-directional I/O port. PORTB can be software programmed for internal weak pull-up on all inputs. RB0/INT can also be selected as an external interrupt pin.
RB1	7	7	8	I/O	TTL	
RB2	8	8	9	I/O	TTL	
RB3	9	9	10	I/O	TTL	
RB4	10	10	11	I/O	TTL	Interrupt-on-change pin.
RB5	11	11	12	I/O	TTL	Interrupt-on-change pin.
RB6	12	12	13	I/O	TTL/ST (2)	Interrupt-on-change pin. Serial programming clock.
RB7	13	13	14	I/O	TTL/ST ⁽²⁾	Interrupt-on-change pin. Serial programming data.
Vss	5	5	5,6	Р	—	Ground reference for logic and I/O pins.
Vdd	14	14	15,16	Р	—	Positive supply for logic and I/O pins.
Legend: I= input	O =	Output		I/O = Ir	put/Output	P = Power

TABLE 1-1:PIC16F84A PINOUT DESCRIPTION

2: This buffer is a Schmitt Trigger input when used in Serial Programming mode.

3: This buffer is a Schmitt Trigger input when configured in RC oscillator mode and a CMOS input otherwise.

3.1 Reading the EEPROM Data Memory

To read a data memory location, the user must write the address to the EEADR register and then set control bit RD (EECON1<0>). The data is available, in the very next cycle, in the EEDATA register; therefore, it can be read in the next instruction. EEDATA will hold this value until another read or until it is written to by the user (during a write operation).

EXAMPLE 3-1: DATA EEPROM READ

BCF	STATUS, RPO	;	Bank 0
MOVLW	CONFIG_ADDR	;	
MOVWF	EEADR	;	Address to read
BSF	STATUS, RPO	;	Bank 1
BSF	EECON1, RD	;	EE Read
BCF	STATUS, RPO	;	Bank 0
MOVF	EEDATA, W	;	W = EEDATA

3.2 Writing to the EEPROM Data Memory

To write an EEPROM data location, the user must first write the address to the EEADR register and the data to the EEDATA register. Then the user must follow a specific sequence to initiate the write for each byte.

EXAMPLE 3-2: DATA EEPROM WRITE

		BSF	STATUS, F	RP0	;	Bank 1
		BCF	INICON, C	315	ï	DISADIE INIS.
		BSF	EECON1, W	VREN	;	Enable Write
		MOVLW	55h		;	
		MOVWF	EECON2		;	Write 55h
	_ e	MOVLW	AAh		;	
Q.	2 0	MOVWF	EECON2		;	Write AAh
	n en	BSF	EECON1,WF	2	;	Set WR bit
Q	eq 1				;	begin write
	2 00	BSF	INTCON, G	GIE	;	Enable INTs.

The write will not initiate if the above sequence is not exactly followed (write 55h to EECON2, write AAh to EECON2, then set WR bit) for each byte. We strongly recommend that interrupts be disabled during this code segment. Additionally, the WREN bit in EECON1 must be set to enable write. This mechanism prevents accidental writes to data EEPROM due to errant (unexpected) code execution (i.e., lost programs). The user should keep the WREN bit clear at all times, except when updating EEPROM. The WREN bit is not cleared by hardware.

After a write sequence has been initiated, clearing the WREN bit will not affect this write cycle. The WR bit will be inhibited from being set unless the WREN bit is set.

At the completion of the write cycle, the WR bit is cleared in hardware and the EE Write Complete Interrupt Flag bit (EEIF) is set. The user can either enable this interrupt or poll this bit. EEIF must be cleared by software.

3.3 Write Verify

Depending on the application, good programming practice may dictate that the value written to the Data EEPROM should be verified (Example 3-3) to the desired value to be written. This should be used in applications where an EEPROM bit will be stressed near the specification limit.

Generally, the EEPROM write failure will be a bit which was written as a '0', but reads back as a '1' (due to leakage off the bit).

EXAMPLE 3-3: WRITE VERIFY

	BCF	STATUS, RPO	;	Bank 0
	:		;	Any code
	:		;	can go here
	MOVF	EEDATA,W	;	Must be in Bank 0
	BSF	STATUS, RPO	;	Bank 1
READ				
	BSF	EECON1, RD	;	YES, Read the
			;	value written
	BCF	STATUS, RPO	;	Bank 0
			;	
			;	Is the value written
			;	(in W reg) and
			;	read (in EEDATA)
			;	the same?
			;	
	SUBWF	EEDATA, W	;	
	BTFSS	STATUS, Z	;	Is difference 0?
	GOTO	WRITE_ERR	;	NO, Write error

TABLE 3-1: REGISTERS/BITS ASSOCIATED WITH DATA EEPROM

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other RESETS
08h	EEDATA	EEPRO	EEPROM Data Register							XXXX XXXX	uuuu uuuu
09h	EEADR	EEPRO	EEPROM Address Register								uuuu uuuu
88h	EECON1		— — — EEIF WRERR WREN WR RD							0 x000	0 q000
89h	EECON2	EEPROM Control Register 2									

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0', q = value depends upon condition. Shaded cells are not used by data EEPROM.

TABLE 4-1: PORTA FUNCTIONS

Name	Bit0	Buffer Type	Function
RA0	bit0	TTL	Input/output
RA1	bit1	TTL	Input/output
RA2	bit2	TTL	Input/output
RA3	bit3	TTL	Input/output
RA4/T0CKI	bit4	ST	Input/output or external clock input for TMR0. Output is open drain type.

Legend: TTL = TTL input, ST = Schmitt Trigger input

TABLE 4-2: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other RESETS
05h	PORTA	—	_	_	RA4/T0CKI	RA3	RA2	RA1	RA0	x xxxx	u uuuu
85h	TRISA	_			TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1 1111	1 1111

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are unimplemented, read as '0'.

6.2 Oscillator Configurations

6.2.1 OSCILLATOR TYPES

The PIC16F84A can be operated in four different oscillator modes. The user can program two configuration bits (FOSC1 and FOSC0) to select one of these four modes:

- LP Low Power Crystal
- XT Crystal/Resonator
- HS High Speed Crystal/Resonator
- RC Resistor/Capacitor

6.2.2 CRYSTAL OSCILLATOR/CERAMIC RESONATORS

In XT, LP, or HS modes, a crystal or ceramic resonator is connected to the OSC1/CLKIN and OSC2/CLKOUT pins to establish oscillation (Figure 6-1).

FIGURE 6-1: CRYSTAL/CERAMIC RESONATOR OPERATION (HS, XT OR LP OSC CONFIGURATION)



- Note 1: See Table 6-1 for recommended values of C1 and C2.
 - **2:** A series resistor (Rs) may be required for AT strip cut crystals.

The PIC16F84A oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in XT, LP, or HS modes, the device can have an external clock source to drive the OSC1/CLKIN pin (Figure 6-2).



TABLE 6-1:CAPACITOR SELECTION FOR
CERAMIC RESONATORS

Ranges Tested:							
Mode	Freq	OSC1/C1	OSC2/C2				
ХТ	455 kHz 2.0 MHz 4.0 MHz	47 - 100 pF 15 - 33 pF 15 - 33 pF					
HS	8.0 MHz 10.0 MHz	15 - 33 pF 15 - 33 pF	15 - 33 pF 15 - 33 pF				
Note: Ro idu Hi of sta gu its cc ap ne	ecommended entical to the r gher capacita the oscillato art-up time. The idance only. a own charac onsult the reso opropriate val- ents.	values of C1 ranges tested nce increases r, but also ir hese values a Since each re teristics, the onator manufa lues of exte	and C2 are in this table. Is the stability perceases the re for design esonator has user should cturer for the rnal compo-				

Note:	When using resonators with frequencies						
	above 3.5 MHz, the use of HS mode rather						
	than XT mode, is recommended. HS mode						
	may be used at any VDD for which the						
	controller is rated.						

6.3 RESET

The PIC16F84A differentiates between various kinds of RESET:

- Power-on Reset (POR)
- MCLR during normal operation
- MCLR during SLEEP
- WDT Reset (during normal operation)
- WDT Wake-up (during SLEEP)

Figure 6-4 shows a simplified block diagram of the On-Chip RESET Circuit. The $\overline{\text{MCLR}}$ Reset path has a noise filter to ignore small pulses. The electrical specifications state the pulse width requirements for the $\overline{\text{MCLR}}$ pin.

Some registers are not affected in any RESET condition; their status is unknown on a POR and unchanged in any other RESET. Most other registers are reset to a "RESET state" on POR, MCLR or WDT Reset during normal operation and on MCLR during SLEEP. They are not affected by a WDT Reset during SLEEP, since this RESET is viewed as the resumption of normal operation.

Table 6-3 gives a description of RESET conditions for the program counter (PC) and the STATUS register. Table 6-4 gives a full description of RESET states for all registers.

The $\overline{\text{TO}}$ and $\overline{\text{PD}}$ bits are set or cleared differently in different RESET situations (Section 6.7). These bits are used in software to determine the nature of the RESET.





TABLE 6-3: RESET CONDITION FOR PROGRAM COUNTER AND THE STATUS REGISTER

Condition	Program Counter	STATUS Register
Power-on Reset	000h	0001 1xxx
MCLR during normal operation	000h	000u uuuu
MCLR during SLEEP	000h	0001 0uuu
WDT Reset (during normal operation)	000h	0000 luuu
WDT Wake-up	PC + 1	uuu0 0uuu
Interrupt wake-up from SLEEP	PC + 1 ⁽¹⁾	uuul Ouuu

Legend: u = unchanged, x = unknown

Note 1: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

6.4 Power-on Reset (POR)

A Power-on Reset pulse is generated on-chip when VDD rise is detected (in the range of 1.2V - 1.7V). To take advantage of the POR, just tie the MCLR pin directly (or through a resistor) to VDD. This will eliminate external RC components usually needed to create Power-on Reset. A minimum rise time for VDD must be met for this to operate properly. See Electrical Specifications for details.

When the device starts normal operation (exits the RESET condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in RESET until the operating conditions are met.

For additional information, refer to Application Note AN607, "*Power-up Trouble Shooting*."

The POR circuit does not produce an internal RESET when VDD declines.

6.5 **Power-up Timer (PWRT)**

The Power-up Timer (PWRT) provides a fixed 72 ms nominal time-out (TPWRT) from POR (Figures 6-6 through 6-9). The Power-up Timer operates on an internal RC oscillator. The chip is kept in RESET as long as the PWRT is active. The PWRT delay allows the VDD to rise to an acceptable level (possible exception shown in Figure 6-9).

A configuration bit, PWRTE, can enable/disable the PWRT. See Register 6-1 for the operation of the PWRTE bit for a particular device.

The power-up time delay TPWRT will vary from chip to chip due to VDD, temperature, and process variation. See DC parameters for details.

6.6 Oscillator Start-up Timer (OST)

The Oscillator Start-up Timer (OST) provides a 1024 oscillator cycle delay (from OSC1 input) after the PWRT delay ends (Figure 6-6, Figure 6-7, Figure 6-8 and Figure 6-9). This ensures the crystal oscillator or resonator has started and stabilized.

The OST time-out (TOST) is invoked only for XT, LP and HS modes and only on Power-on Reset or wake-up from SLEEP.

When VDD rises very slowly, it is possible that the TPWRT time-out and TOST time-out will expire before VDD has reached its final value. In this case (Figure 6-9), an external Power-on Reset circuit may be necessary (Figure 6-5).

FIGURE 6-5: EXTI RES

EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)



- Note 1: External Power-on Reset circuit is required only if VDD power-up rate is too slow. The diode D helps discharge the capacitor quickly when VDD powers down.
 - 2: R < 40 k Ω is recommended to make sure that voltage drop across R does not exceed 0.2V (max leakage current spec on MCLR pin is 5 μ A). A larger voltage drop will degrade VIH level on the MCLR pin.
 - **3:** $R1 = 100\Omega$ to 1 k Ω will limit any current flowing into MCLR from external capacitor C, in the event of a MCLR pin breakdown due to ESD or EOS.



FIGURE 6-7: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 2



FIGURE 6-8: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD): FAST VDD RISE TIME



6.9 Context Saving During Interrupts

During an interrupt, only the return PC value is saved on the stack. Typically, users wish to save key register values during an interrupt (e.g., W register and STATUS register). This is implemented in software.

The code in Example 6-1 stores and restores the STATUS and W register's values. The user defined registers, W_TEMP and STATUS_TEMP are the temporary storage locations for the W and STATUS registers values.

Example 6-1 does the following:

- a) Stores the W register.
- b) Stores the STATUS register in STATUS_TEMP.
- c) Executes the Interrupt Service Routine code.
- d) Restores the STATUS (and bank select bit) register.
- e) Restores the W register.

PUSH	MOVWF	W_TEMP	; Copy W to TEMP register,
	SWAPF	STATUS, W	; Swap status to be saved into W
	MOVWF	STATUS_TEMP	; Save status to STATUS_TEMP register
ISR	:		:
	:		; Interrupt Service Routine
	:		; should configure Bank as required
	:		;
POP	SWAPF	STATUS_TEMP,W	; Swap nibbles in STATUS_TEMP register
			; and place result into W
	MOVWF	STATUS	; Move W into STATUS register
			; (sets bank to original state)
	SWAPF	W_TEMP, F	; Swap nibbles in W_TEMP and place result in W_TEMP
	SWAPF	W_TEMP, W	; Swap nibbles in W_TEMP and place result into W
1			

6.10 Watchdog Timer (WDT)

The Watchdog Timer is a free running On-Chip RC Oscillator which does not require any external components. This RC oscillator is separate from the RC oscillator of the OSC1/CLKIN pin. That means that the WDT will run even if the clock on the OSC1/CLKIN and OSC2/CLKOUT pins of the device has been stopped, for example, by execution of a SLEEP instruction. During normal operation, a WDT time-out generates a device RESET. If the device is in SLEEP mode, a WDT wake-up causes the device to wake-up and continue with normal operation. The WDT can be permanently disabled by programming configuration bit WDTE as a '0' (Section 6.1).

6.10.1 WDT PERIOD

The WDT has a nominal time-out period of 18 ms, (with no prescaler). The time-out periods vary with temperature, VDD and process variations from part to part (see DC specs). If longer time-out periods are desired, a prescaler with a division ratio of up to 1:128 can be assigned to the WDT under software control by writing to the OPTION_REG register. Thus, time-out periods up to 2.3 seconds can be realized.

The CLRWDT and SLEEP instructions clear the WDT and the postscaler (if assigned to the WDT) and prevent it from timing out and generating a device RESET condition.

The $\overline{\text{TO}}$ bit in the STATUS register will be cleared upon a WDT time-out.

NOTES:

PIC16F84A

BTFSC	Bit Test, Skip if Clear	
Syntax:	[<i>label</i>] BTFSC f,b	
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$	
Operation:	skip if $(f < b >) = 0$	
Status Affected:	None	
Description:	If bit 'b' in register 'f' is '1', the next instruction is executed. If bit 'b' in register 'f' is '0', the next instruction is discarded, and a NOP is executed instead, making this a 2TCY instruction.	

CLRWDT	Clear Watchdog Timer		
Syntax:	[label] CLRWDT		
Operands:	None		
Operation:	$\begin{array}{l} 00h \rightarrow WDT \\ 0 \rightarrow WDT \text{ prescaler,} \\ 1 \rightarrow \overline{TO} \\ 1 \rightarrow \overline{PD} \end{array}$		
Status Affected:	TO, PD		
Description:	CLRWDT instruction resets the Watchdog Timer. It also resets the prescaler of the WDT. Status bits TO and PD are set.		

CALL	Call Subroutine
Syntax:	[<i>label</i>] CALL k
Operands:	$0 \leq k \leq 2047$
Operation:	(PC)+ 1 \rightarrow TOS, k \rightarrow PC<10:0>, (PCLATH<4:3>) \rightarrow PC<12:11>
Status Affected:	None
Description:	Call Subroutine. First, return address (PC+1) is pushed onto the stack. The eleven-bit immedi- ate address is loaded into PC bits <10:0>. The upper bits of the PC are loaded from PCLATH. CALL is a two-cycle instruction.

COMF	Complement f		
Syntax:	[<i>label</i>] COMF f,d		
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in [0,1] \end{array}$		
Operation:	$(\overline{f}) \rightarrow (destination)$		
Status Affected:	Z		
Description:	The contents of register 'f' are complemented. If 'd' is 0, the result is stored in W. If 'd' is 1, the result is stored back in register 'f'.		

CLRF	Clear f
Syntax:	[<i>label</i>] CLRF f
Operands:	$0 \leq f \leq 127$
Operation:	$\begin{array}{l} 00h \rightarrow (f) \\ 1 \rightarrow Z \end{array}$
Status Affected:	Z
Description:	The contents of register 'f' are cleared and the Z bit is set.

CLRW	Clear W
Syntax:	[label] CLRW
Operands:	None
Operation:	$\begin{array}{l} 00h \rightarrow (W) \\ 1 \rightarrow Z \end{array}$
Status Affected:	Z
Description:	W register is cleared. Zero bit (Z) is set.

DECF	Decrement f
Syntax:	[<i>label</i>] DECF f,d
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in [0,1] \end{array}$
Operation:	(f) - 1 \rightarrow (destination)
Status Affected:	Z
Description:	Decrement register 'f'. If 'd' is 0, the result is stored in the W regis- ter. If 'd' is 1, the result is stored back in register 'f'.

XORLW	Exclusive OR Literal with W	XORWF	Exclusive OR W with f	
Syntax:	[<i>label</i>] XORLW k	Syntax:	[<i>label</i>] XORWF f,d	
Operands:	$0 \leq k \leq 255$	Operands:	$0 \le f \le 127$	
Operation:	(W) .XOR. $k \rightarrow (W)$		$a \in [0, 1]$	
Status Affected:	atus Affected: Z		(W) .XOR. (f) \rightarrow (destination)	
Description:	The contents of the W register	Status Affected:	Z	
Description: The contents of the W register are XOR'ed with the eight-bit lit- eral 'k'. The result is placed in the W register.		Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.	

9.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Ambient temperature under bias	55°C to +125°C
Storage temperature	65°C to +150°C
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	-0.3V to (VDD + 0.3V)
Voltage on VDD with respect to VSS	-0.3 to +7.5V
Voltage on MCLR with respect to Vss ⁽¹⁾	-0.3 to +14V
Voltage on RA4 with respect to Vss	-0.3 to +8.5V
Total power dissipation ⁽²⁾	
Maximum current out of Vss pin	
Maximum current into VDD pin	
Input clamp current, IIK (VI < 0 or VI > VDD)	± 20 mA
Output clamp current, Iok (Vo < 0 or Vo > VDD)	± 20 mA
Maximum output current sunk by any I/O pin	
Maximum output current sourced by any I/O pin	
Maximum current sunk by PORTA	
Maximum current sourced by PORTA	
Maximum current sunk by PORTB	
Maximum current sourced by PORTB	100 mA
Note 4. Veltage epikes helew Ves at the \overline{MOLD} pin inducing surrants greater t	han 90 mA may aquaa latah un

- **Note 1:** Voltage spikes below Vss at the MCLR pin, inducing currents greater than 80 mA, <u>may</u> cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR pin rather than pulling this pin directly to Vss.
 - **2:** Power dissipation is calculated as follows: Pdis = VDD x {IDD \sum IOH} + \sum {(VDD-VOH) x IOH} + \sum (VOI x IOL).

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

FIGURE 10-3: TYPICAL IDD vs. Fosc OVER VDD (XT MODE, 25°C)







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FIGURE 10-5: TYPICAL IDD vs. Fosc OVER VDD (LP MODE, 25°C)







FIGURE 10-7: AVERAGE FOSC vs. VDD FOR R (RC MODE, C = 22 pF, 25°C)





TABLE 1: CONVERSION CONSIDERATIONS - PIC16C84, PIC16F83/F84, PIC16CR83/CR84, PIC16F84A (CONTINUED)

Difference	PIC16C84	PIC16F83/F84	PIC16CR83/ CR84	PIC16F84A
EEADR<7:6> and IDD	It is recommended that the EEADR<7:6> bits be cleared. When either of these bits is set, the maxi- mum IDD for the device is higher than when both are cleared.	N/A	N/A	N/A
The polarity of the PWRTE bit	PWRTE	PWRTE	PWRTE	PWRTE
Recommended value of REXT for RC oscillator circuits	Rext = 3kΩ - 100kΩ	Rext = 5kΩ - 100kΩ	Rext = 5kΩ - 100kΩ	Rext = 3kΩ - 100kΩ
GIE bit unintentional enable	If an interrupt occurs while the Global Interrupt Enable (GIE) bit is being cleared, the GIE bit may unintentionally be re- enabled by the user's Interrupt Service Routine (the RETFIE instruction).	N/A	N/A	N/A
Packages	PDIP, SOIC	PDIP, SOIC	PDIP, SOIC	PDIP, SOIC, SSOP
Open Drain High Voltage (VoD)	14V	12V	12V	8.5V

APPENDIX C: MIGRATION FROM BASELINE TO MID-RANGE DEVICES

This section discusses how to migrate from a baseline device (i.e., PIC16C5X) to a mid-range device (i.e., PIC16CXXX).

The following is the list of feature improvements over the PIC16C5X microcontroller family:

- Instruction word length is increased to 14-bits. This allows larger page sizes, both in program memory (2K now as opposed to 512K before) and the register file (128 bytes now versus 32 bytes before).
- 2. A PC latch register (PCLATH) is added to handle program memory paging. PA2, PA1 and PA0 bits are removed from the STATUS register and placed in the OPTION register.
- 3. Data memory paging is redefined slightly. The STATUS register is modified.
- 4. Four new instructions have been added: RETURN, RETFIE, ADDLW, and SUBLW. Two instructions, TRIS and OPTION, are being phased out, although they are kept for compatibility with PIC16C5X.
- 5. OPTION and TRIS registers are made addressable.
- 6. Interrupt capability is added. Interrupt vector is at 0004h.
- 7. Stack size is increased to eight-deep.
- 8. RESET vector is changed to 0000h.
- RESET of all registers is revisited. Five different RESET (and wake-up) types are recognized. Registers are reset differently.
- 10. Wake-up from SLEEP through interrupt is added.
- 11. Two separate timers, the Oscillator Start-up Timer (OST) and Power-up Timer (PWRT), are included for more reliable power-up. These timers are invoked selectively to avoid unnecessary delays on power-up and wake-up.
- 12. PORTB has weak pull-ups and interrupt-onchange features.
- 13. T0CKI pin is also a port pin (RA4/T0CKI).
- 14. FSR is a full 8-bit register.
- 15. "In system programming" is made possible. The user can program PIC16CXX devices using only five pins: VDD, VSS, VPP, RB6 (clock) and RB7 (data in/out).

To convert code written for PIC16C5X to PIC16F84A, the user should take the following steps:

- 1. Remove any program memory page select operations (PA2, PA1, PA0 bits) for CALL, GOTO.
- 2. Revisit any computed jump operations (write to PC or add to PC, etc.) to make sure page bits are set properly under the new scheme.
- 3. Eliminate any data memory page switching. Redefine data variables for reallocation.
- 4. Verify all writes to STATUS, OPTION, and FSR registers since these have changed.
- 5. Change RESET vector to 0000h.

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